



**MiniSKiiP®0**

## 3-phase bridge inverter

### SKiiP 02AC066V1

#### Preliminary Data

#### Features

- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

#### Typical Applications

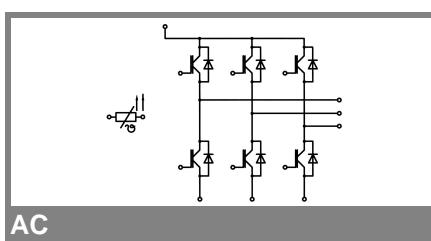
- Inverter up to 5 kVA
- Typical motor power 2,2 kW

#### Remarks

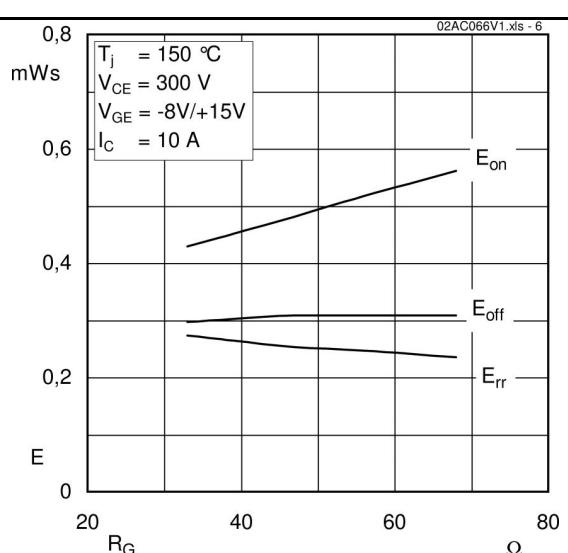
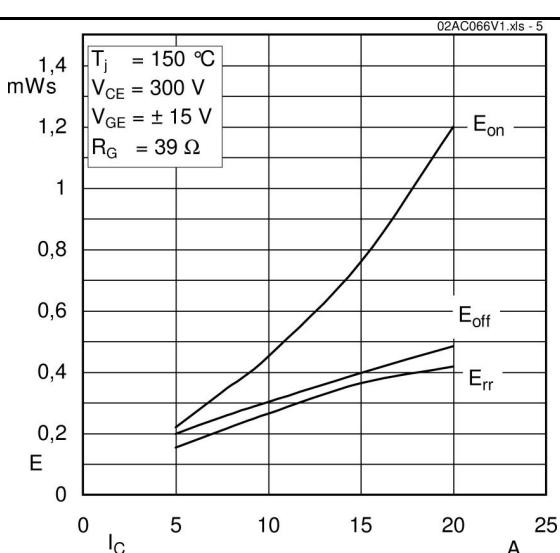
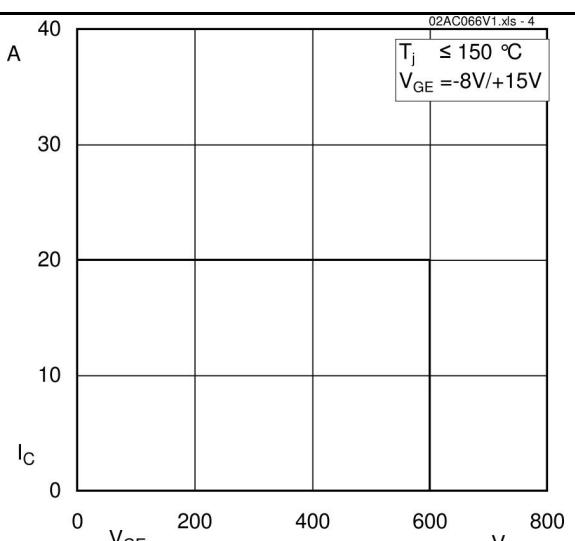
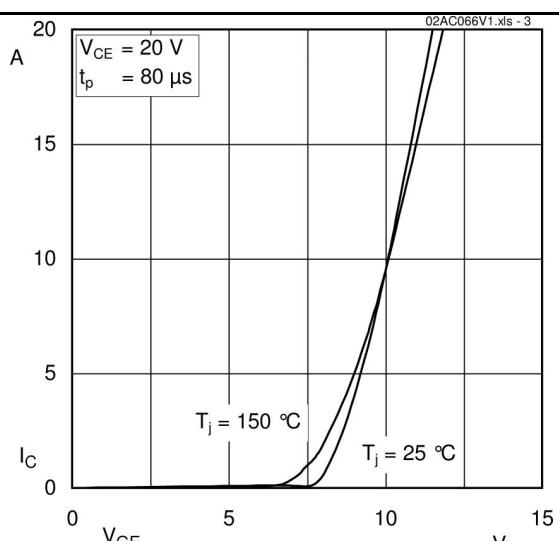
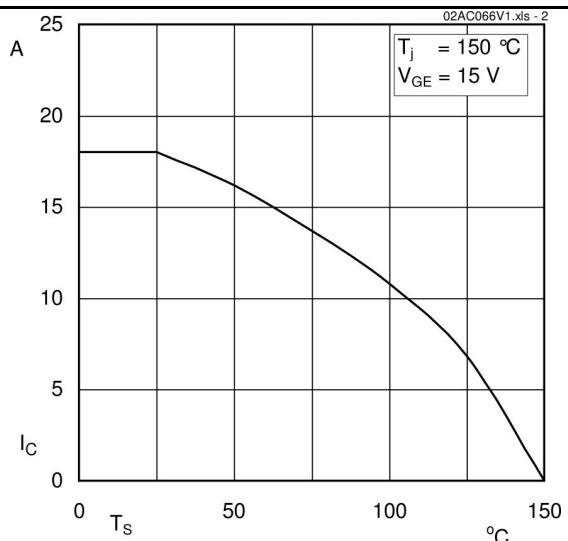
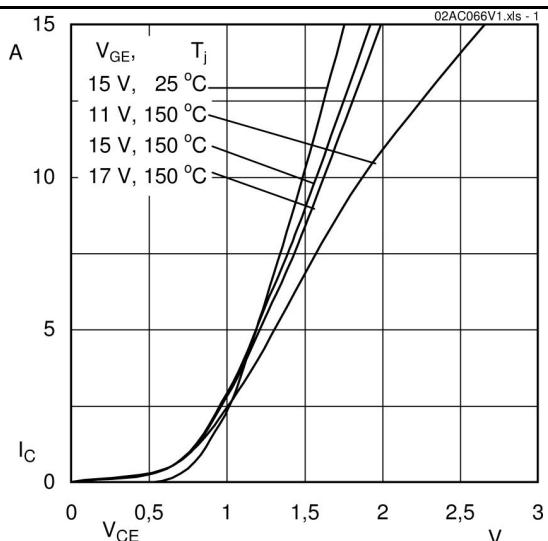
- Case temperature limited to  $T_C = 125^\circ\text{C}$  max.
- Product reliability results are valid for  $T_j = 150^\circ\text{C}$
- SC data:  $t_p \leq 6 \mu\text{s}$ ;  $V_{GE} \leq 15 \text{ V}$ ;  $T_j = 150^\circ\text{C}$ ;  $V_{CC} = 360 \text{ V}$
- $V_{CESat}$ ,  $V_F$  = chip level value

Absolute Maximum Ratings		$T_S = 25^\circ\text{C}$ , unless otherwise specified		
Symbol	Conditions	Values		Units
<b>IGBT - Inverter</b>				
$V_{CES}$		600		V
$I_C$	$T_s = 25 (70)^\circ\text{C}, T_j = 150^\circ\text{C}$	17 (14)	A	
$I_C$	$T_s = 25 (70)^\circ\text{C}, T_j = 175^\circ\text{C}$	20 (16)	A	
$I_{CRM}$	$t_p = 1 \text{ ms}$	20	A	
$V_{GES}$		$\pm 20$	V	
$T_j$		-40...+175		$^\circ\text{C}$
<b>Diode - Inverter</b>				
$I_F$	$T_s = 25 (70)^\circ\text{C}, T_j = 150^\circ\text{C}$	20 (15)	A	
$I_F$	$T_s = 25 (70)^\circ\text{C}, T_j = 175^\circ\text{C}$	20 (18)	A	
$I_{FRM}$	$t_p = 1 \text{ ms}$	20	A	
$T_j$		-40...+175		$^\circ\text{C}$
$I_{tRMS}$	per power terminal (20 A / spring)	20	A	
$T_{stg}$	$T_{op} \leq T_{stg}$	-40...+125	$^\circ\text{C}$	
$V_{isol}$	AC, 1 min.	2500	V	

Characteristics		$T_S = 25^\circ\text{C}$ , unless otherwise specified		
Symbol	Conditions	min.	typ.	max.
<b>IGBT - Inverter</b>				
$V_{CESat}$	$I_{Cnom} = 10 \text{ A}, T_j = 25 (150)^\circ\text{C}$	1,1	1,45 (1,65)	1,85 (2,05)
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 1 \text{ mA}$		5,8	V
$V_{CE(TO)}$	$T_j = 25 (150)^\circ\text{C}$	0,9 (0,7)	1,1 (1)	V
$r_T$	$T_j = 25 (150)^\circ\text{C}$	60 (100)	80 (110)	$\text{m}\Omega$
$C_{ies}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	0,58		nF
$C_{oes}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	0,12		nF
$C_{res}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	0,06		nF
$R_{CC' + EE'}$	spring contact-chip $T_s = 25 (150)^\circ\text{C}$			$\text{m}\Omega$
$R_{th(j-s)}$	per IGBT	2		K/W
$t_{d(on)}$	under following conditions	28		ns
$t_r$	$V_{CC} = 300 \text{ V}, V_{GE} = -15\text{V/+15V}$	30		ns
$t_{d(off)}$	$I_{Cnom} = 10 \text{ A}, T_j = 150^\circ\text{C}$	190		ns
$t_f$	$R_{Gon} = R_{Goff} = 39 \Omega$	37		ns
$E_{on}(E_{off})$	inductive load	0,45 (0,3)		mJ
<b>Diode - Inverter</b>				
$V_F = V_{EC}$	$I_{Fnom} = 10 \text{ A}, T_j = 25 (150)^\circ\text{C}$	1,3 (1,3)	1,6 (1,6)	V
$V_{(TO)}$	$T_j = 25 (150)^\circ\text{C}$	0,9 (0,8)	1 (0,9)	V
$r_T$	$T_j = 25 (150)^\circ\text{C}$	40 (50)	60 (70)	$\text{m}\Omega$
$R_{th(j-s)}$	per diode	2,5		K/W
$I_{RRM}$	under following conditions	13,5		A
$Q_{rr}$	$I_{Fnom} = 10 \text{ A}, V_R = 300 \text{ V}$	1,3		$\mu\text{C}$
$E_{rr}$	$V_{GE} = 0 \text{ V}, T_j = 150^\circ\text{C}$	0,3		mJ
	$di_F/dt = 600 \text{ A}/\mu\text{s}$			
<b>Temperature Sensor</b>				
$R_{ts}$	$3\%, T_r = 25 (100)^\circ\text{C}$	1000(1670)		$\Omega$
<b>Mechanical Data</b>				
$m$		21,5		g
$M_s$	Mounting torque	2	2,5	Nm



# SKiiP 02AC066V1



# SKiiP 02AC066V1

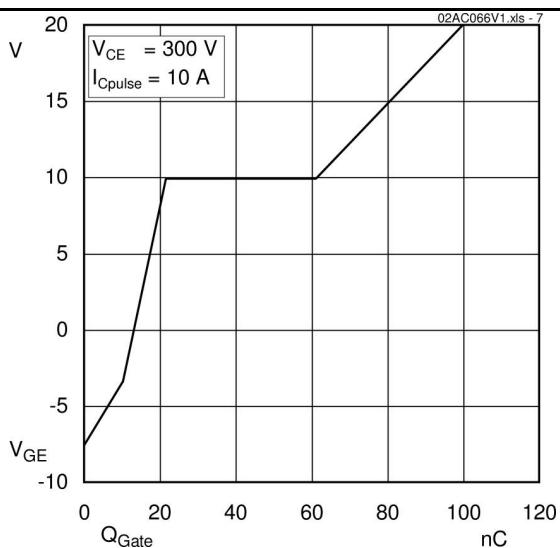


Fig. 7 Typ. Gate charge characteristic

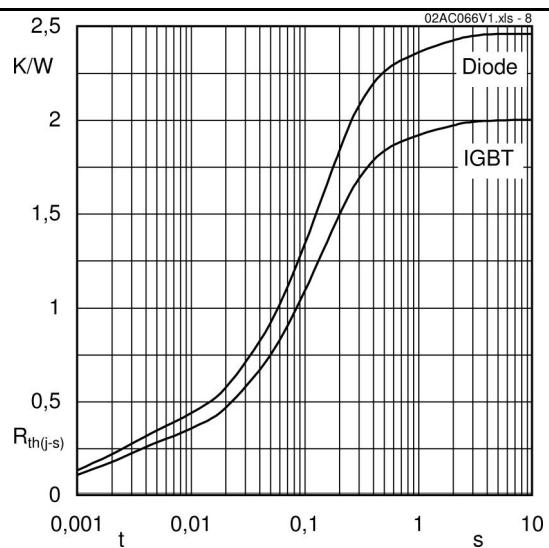


Fig. 8 Typ. thermal impedance

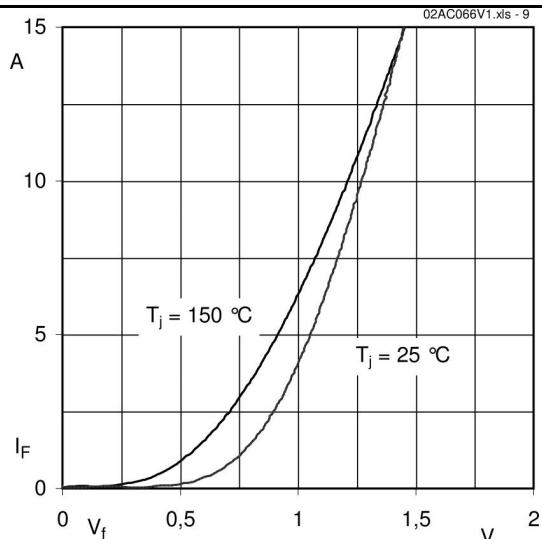
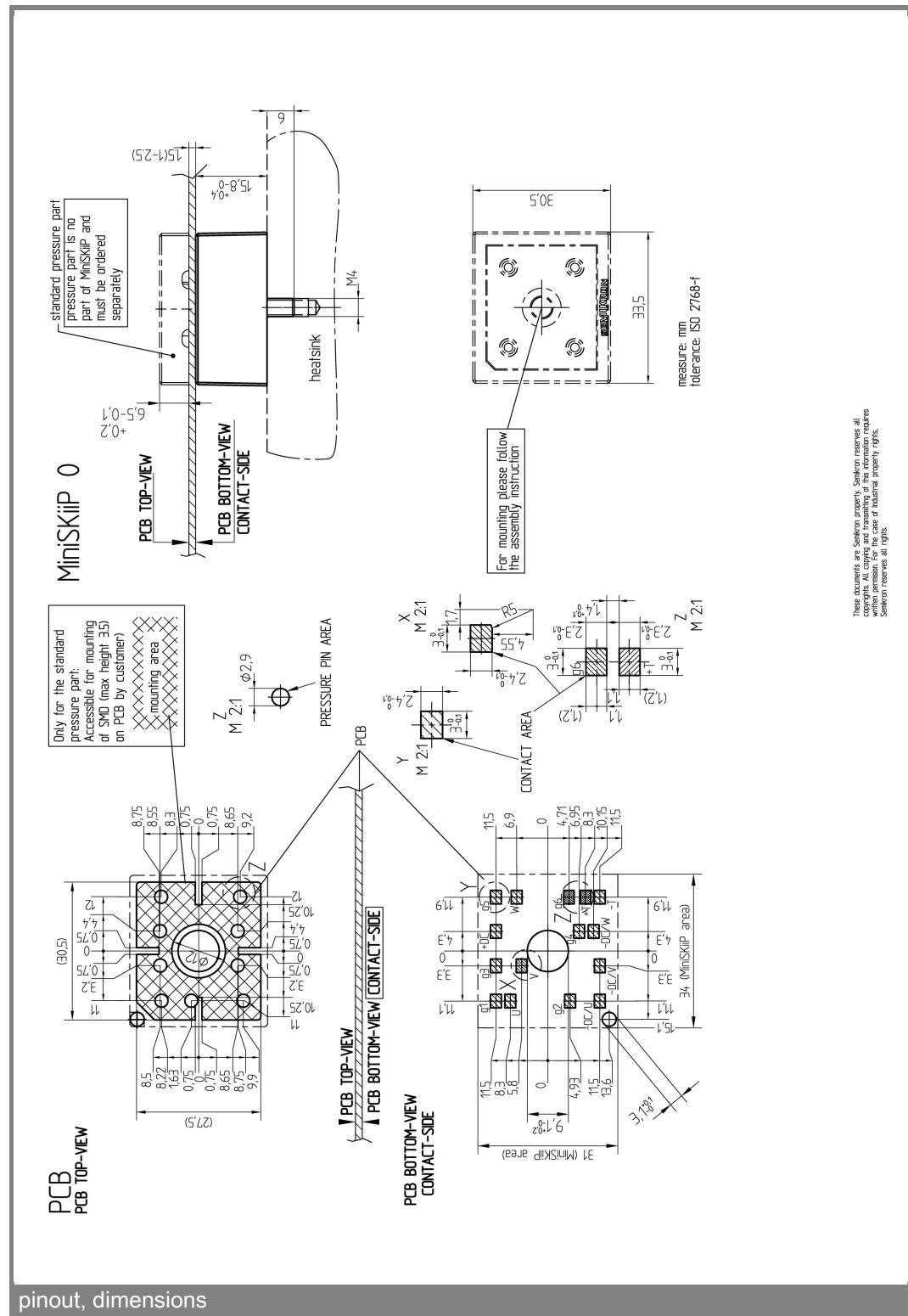
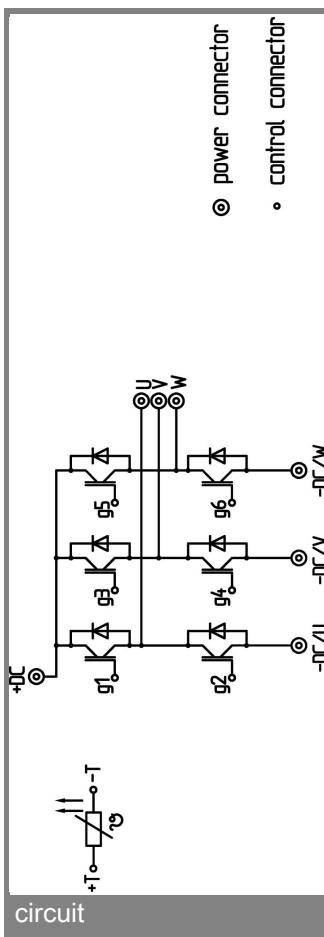


Fig. 9 Typ. freewheeling diode forward characteristic



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.